502919367 08/04/2014

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KANG WU	12/02/2013
BO TIAN	12/02/2013

RECEIVING PARTY DATA

Name:	HONG FU JIN PRECISION INDUSTRY (ShenZhen) CO., LTD.	
Street Address:	eet Address: No. 2, 2nd Donghuan Road,Longhua Town, Bao' an District	
City:	Shenzhen	
State/Country:	CHINA	
	HON HAI PRECISION INDUSTRY CO., LTD.	
Name:	HON HAI PRECISION INDUSTRY CO., LTD.	
Name: Street Address:	HON HAI PRECISION INDUSTRY CO., LTD. 66, Chung Shan Road, Tu-Cheng Dist.	
	· ·	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14097243	

CORRESPONDENCE DATA

Fax Number: (713)456-2836

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Address Line 1: 1000 LOUISIANA STREET, FIFTY-THIRD FLOOR

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ATTORNEY DOCKET NUMBER:	US46591
NAME OF SUBMITTER:	ZHIGANG MA
SIGNATURE:	/Zhigang Ma/
DATE SIGNED:	08/04/2014

Total Attachments: 2

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502919367 PATENT REEL: 033451 FRAME: 0649

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1.	KANG WU	, residing at	Shenzhen, Guangdong, China
2.	BO TIAN	, residing at	Shenzhen, Guangdong, China
3.		, residing at	
4.		, residing at	
5.		, residing at	
6.		, residing at	
7.		residing at	
8.		, residing at	

Shenzhen City, Guangdong Province 518109, P.R.C. and HON HAI PRECISION INDUSTRY CO., LTD. having a principal place of business at 66,Chung Shan Road, Tu-Cheng Dist., New Taipei City, Taiwan, R.O.C. hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as HARD DISK DRIVE MODULE HAVING TEMPERATURE DETECTING FUNCTION for which the undersigned

[] previously executed Ser. No.	and filing	date of	
[x]	is executing concurrently herewith			

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

PATENT REEL: 033451 FRAME: 0650

1.	KANG WU	2013-12-2 Date
2.	BO TIAN	2013 - 12-2 Date
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PATENT REEL: 033451 FRAME: 0651